Declaration For Patent Application

專利申請宣誓書

| 如下所述發明者,我在此宣告: | As a below named inventor, I hereby declare that: | | |
|--|---|--|--|
| 我的地址和國籍身份都列在底下我的姓名之後: | My residence address and citizenship are as stated below next to my name, | | |
| 我相信我是原創的、第一個和單獨的發明者(若只列出一人姓名)或是原創的、第一個和共同的發明者(若列出一人以上姓名)。我要求的主題及申請的專利是關於發明 | I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled | | |
| 其說明書: | the specification of which | | |
| (註明一項) | (check one) | | |
| ◎隙同附上 | is attached hereto. | | |
| 「於 | was filed on as Application Serial No | | |
| 於 提出修正 | and was amended on | | |
| (如適用於此) | (if applicable) | | |
| 我在此陳述我已經再次查看並明瞭以上所指的說明書的內容,包括上述的要求及修正。 | I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. | | |
| 我,按照聯邦規則法典第三十七冊第一·五六條(甲)的條文,認知我提供與審查此申請書有關的重要資料的義務。 | I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). | | |
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Chinese Language Declaration

我,按照聯邦法典第三十五冊第一一九條的條文, 依據下列外國專利申請書或發明者證明申請書在此 要求受益優先權,並指出任何上述要求優先權所依 據的外國專利申請書或發明者證明申請書其申請日 在本申讀書的申請日之前。 I her by claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

| | application on which priority is claimed: | | | | |
|---|--|--|--|---|--|
| 先前外國申請: Prior Foreign Application(s) | | | | 優先權要求 <u>Priority Claimed</u> | |
| | | | | | |
| (號碼) (Number) | (國名) (Country) | 申請月/日/年) (Month/Day/ Year Filed | 是 d) Yes | 否 No | |
| | | | | | |
| (號碼) (Number) | (國名) (Country) | 申請月/日/年) (Month/Day/ Year Filed | 是 d) Yes | 否 No | |
| | | | _ | П | |
| (號碼) (Number) | (國名) (Country) | 申請月/日/年) (Month/Day/ Year Filed | 是 d) Yes | 否 No | |
| 我,按照聯邦法典第三十五冊第 依據下列的美國申請書要求受益 求的主題未曾依聯邦法典第三十 條文在先前的申請書中透露的, 書的申請日和本申請書的國家或 日之間的,我,依聯邦規則法典 五六條(甲)的條文,認知提供軍 | 。至於其中每個要 五冊第一一二條的 而發生在先前申請 國際申請書的申請 第三十七冊第一· | I hereby claim the benestates Code, §120 application(s) listed be subject matter of eac application is not discipled states application in the first paragraph of Title §112, I acknowledge the information as defined in Regulations, §1.56(a) we filing date of the prior a or PCT international filing. | of any U elow and, in the of the ol losed in the e manner pro 35, United e duty to disc n Title 37, Co hich occurred pplication an | nited States sofar as the laims of this prior United ovided by the States Code, close material de of Federal d between the d the national | |
| (申請順次號碼) (申請日期) | (狀況) (已 專利,申請中) | (Application Serial No.) | (Filing Date) | (status) | |

我在此聲明所有就我自己知識之下所做的一切陳述 均屬真實的,而且依資料和信念所做的一切陳述也 相信均是真實的。還有我了解,根據聯邦法典第十 八冊第一〇〇一節的規定,有企圖不實或類似的聲 明時,應受罰款或監禁的,或兩項同時的處分。像 這些企圖不實的聲明會危害到本申請書的合法性或 危害到任何專利的批准。

(申請日期)

(狀況)

(已專利,申請中)

(申請順次號碼)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful fals statements may jeopardiz the validity of the application or any patent issued thereon.

(Filing Date)

(Application Serial No.)

abandoned)

(status)

(patented, pending, abandoned)

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| Chinese Language Declaration | | |
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| Full name of fourth joint inventor, if any | | |
| Inventor's signature Date | | |
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